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AO4620

Complementary Enhancement Mode Field Effect Transistor

General Description

The AO4620 uses advanced trench technology MOSFETs to provide excellent $R_{DS(ON)}$ and low gate charge. The complementary MOSFETs may be used in inverter and other applications.

Features

n-channel $V_{DS}(V) = 30V$ $I_{D} = 7.2A(V_{GS}=10V)$

 $R_{DS(ON)}$ R_{DS}

 $< 24m\Omega \text{ (V}_{GS}=10V)$ $< 36m\Omega \text{ (V}_{GS}=4.5V)$ p-channel -30V

 $-5.3A (V_{GS} = -10V)$

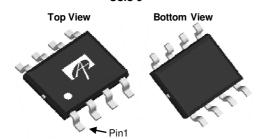
R_{DS(ON)}

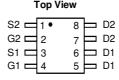
 $< 32m\Omega (V_{GS} = -10V)$ $< 55m\Omega (V_{GS} = -4.5V)$

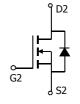
100% UIS tested 100% Rg tested

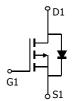












n-channel

p-channel

Absolute Maximum Ratings T_A=25℃ unless otherwise noted

Parameter		Symbol	Max n-channel	Max p-channel	Units	
Drain-Source Voltage		V_{DS}	30	-30	V	
Gate-Source Voltage		V_{GS}	±20	±20	±20 V	
Continuous Drain	T _A =25℃		7.2	-5.3		
Current ^F	T _A =70℃	I _D	6.2	-4.5	Α	
Pulsed Drain Current ^B		I _{DM}	64	-40		
	T _A =25℃	D	2	2	w	
Power Dissipation F	T _A =70℃	$-P_{D}$	1.44	1.44	VV	
Avalanche Current B	-	I _{AR}	9	17	Α	
Repetitive avalanche energy 0.3mH ^B		E _{AR}	12	43	mJ	
Junction and Storage Temperature Range		T_J , T_{STG}	-55 to 150	-55 to 150	C	
				•		

Thermal Characteristics: n-channel and p-channel

Parameter	Symbol	Device	Тур	Max	Units	
Maximum Junction-to-Ambient A	t ≤ 10s	$R_{\theta JA}$	n-ch	50	62.5	℃/W
Maximum Junction-to-Ambient A	Steady-State	Π _θ JA	n-ch	80	100	℃/W
Maximum Junction-to-Lead ^C	Steady-State	$R_{\theta JL}$	n-ch	32	40	€/M
Maximum Junction-to-Ambient A	t ≤ 10s	- R _{eJA}	p-ch	50	62.5	℃/W
Maximum Junction-to-Ambient A	Steady-State	п⊕ЈА	p-ch	80	100	℃/W
Maximum Junction-to-Lead ^C	Steady-State	$R_{ heta JL}$	p-ch	32	40	€/M

N-CHANNEL Electrical Characteristics (T_J=25℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
STATIC P	PARAMETERS		·			
BV _{DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	30			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =30V, V _{GS} =0V			1	μА
		T _J =55℃	=55℃		5	
I_{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} = ±20V			100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ $I_{D}=250\mu A$	1.5	2.1	2.6	V
$I_{D(ON)}$	On state drain current	$V_{GS}=10V$, $V_{DS}=5V$	64			Α
		V _{GS} =10V, I _D =7.2A		17.7	24	mO
$R_{DS(ON)}$	Static Drain-Source On-Resistance	T _J =1	125℃	25	32	mΩ
		V_{GS} =4.5V, I_D =5A		24.8	36	mΩ
g _{FS}	Forward Transconductance	$V_{DS}=5V$, $I_{D}=7.2A$		20		S
V_{SD}	Diode Forward Voltage	$I_S=1A, V_{GS}=0V$		0.74	1	V
Is	Maximum Body-Diode Continuous Current				2.5	Α
I _{SM}	Pulsed Body-Diode Current ^B				64	Α
DYNAMIC	PARAMETERS		•			
C _{iss}	Input Capacitance			373	448	pF
C _{oss}	Output Capacitance	V_{GS} =0V, V_{DS} =15V, f=1MHz		67		pF
C _{rss}	Reverse Transfer Capacitance			41		pF
R_g	Gate resistance	$V_{GS}=0V$, $V_{DS}=0V$, $f=1MHz$		1.8	2.8	Ω
SWITCHII	NG PARAMETERS		•			
Q _g (10V)	Total Gate Charge			7.2	11	nC
Q _g (4.5V)	Total Gate Charge] -V _{GS} =10V, V _{DS} =15V, I _D =7.2.	^	3.5		nC
Q_{gs}	Gate Source Charge	V _{GS} =10V, V _{DS} =13V, I _D =7.2	^	1.3		nC
Q_{gd}	Gate Drain Charge			1.7		nC
t _{D(on)}	Turn-On DelayTime			4.5		ns
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =15V, R_L =2.1	Ω,	2.7		ns
t _{D(off)}	Turn-Off DelayTime	$R_{GEN}=3\Omega$		14.9		ns
t _f	Turn-Off Fall Time			2.9		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =7.2A, dI/dt=100A/μs		10.5	12.6	ns
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =7.2A, dI/dt=100A/μs		4.5		nC

A: The value of R_{BJA} is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ$ C. The value in any given application depends on the user's specific board design. The current rating is based on the t $\, \leq \,$ 10s thermal resistance rating.

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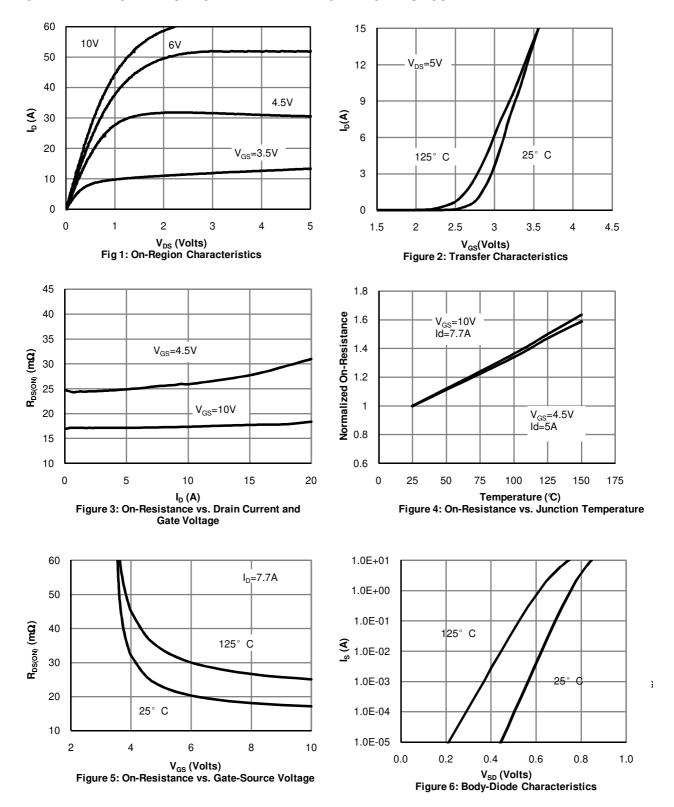
B: Repetitive rating, pulse width limited by junction temperature.

C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using <300 μ s pulses, duty cycle 0.5% max. E. These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T $_A$ =25 $^\circ$ C. The SOA curve provides a single pulse rating.

F.The power dissipation and current rating are based on the $t \le 10s$ thermal resistance rating. Rev 8: May 2012

N-CHANNEL TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



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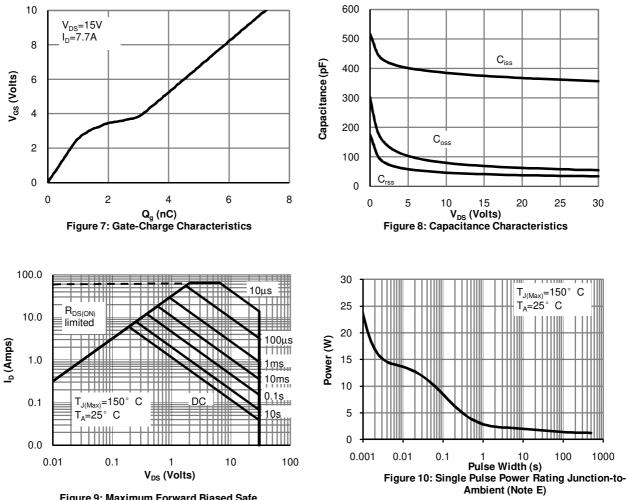
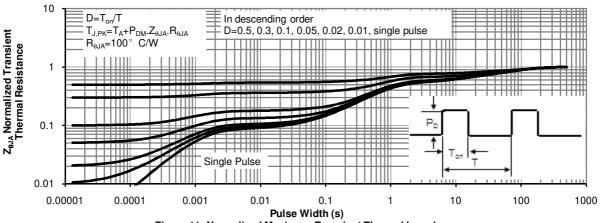


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)



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Figure 11: Normalized Maximum Transient Thermal Impedance

P-CHANNEL Electrical Characteristics (T_J=25℃ unless otherwise noted)

Symbol	Parameter	Conditions		Тур	Max	Units
STATIC F	PARAMETERS					
BV _{DSS}	Drain-Source Breakdown Voltage	$I_D = -250 \mu A, V_{GS} = 0 V$	-30			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-30V, V _{GS} =0V			-1	μА
		T _J =55℃			-5	
I _{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} =±20V			±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ $I_{D}=-250\mu A$	-1.3	-1.85	-2.4	V
$I_{D(ON)}$	On state drain current	V _{GS} =-10V, V _{DS} =-5V	-40			Α
		V _{GS} =-10V, I _D =-5.3A		23	32	mΩ
$R_{DS(ON)}$	Static Drain-Source On-Resistance	T _J =125℃		31.5		
		V_{GS} =-4.5V, I_{D} =-4.5A		33	55	mΩ
g _{FS}	Forward Transconductance	V_{DS} =-5V, I_{D} =-5.3A		19		S
V_{SD}	Diode Forward Voltage	I _S =-1A,V _{GS} =0V		-0.8	-1	V
Is	Maximum Body-Diode Continuous Current				-3.5	Α
I _{SM}	M Pulsed Body-Diode Current ^B				-40	Α
DYNAMIC	PARAMETERS					
C _{iss}	Input Capacitance			760		pF
C _{oss}	Output Capacitance	V_{GS} =0V, V_{DS} =-15V, f=1MHz		140		pF
C _{rss}	Reverse Transfer Capacitance			95		pF
R_g	Gate resistance	V_{GS} =0V, V_{DS} =0V, f=1MHz		3.2	5	Ω
SWITCHII	NG PARAMETERS					
Q _g (10V)	Total Gate Charge (10V)			13.6	16	nC
Q _g (4.5V)	Total Gate Charge (4.5V)	V _{GS} =-10V, V _{DS} =-15V, I _D =-5.3A		6.7		nC
Q_{gs}	Gate Source Charge	V _{GS} -10V, V _{DS} -13V, I _D -3.3A		2.5		nC
Q_{gd}	Gate Drain Charge	1		3.2		nC
t _{D(on)}	Turn-On DelayTime			8		ns
t _r	Turn-On Rise Time	V_{GS} =-10V, V_{DS} =-15V, R_L =2.8 Ω ,		6		ns
t _{D(off)}	Turn-Off DelayTime	$R_{GEN}=3\Omega$		17		ns
t _f	Turn-Off Fall Time]		5		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =-5.3A, dI/dt=100A/μs		15		ns
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =-5.3A, dI/dt=100A/μs		9.7		nC

A: The value of R $_{\theta JA}$ is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T $_A$ =25 $^\circ$ C. The value in any given application depends on the user's specific board design. The current rating is based on the $t \le 10s$ thermal resistance rating. B: Repetitive rating, pulse width limited by junction temperature.

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C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

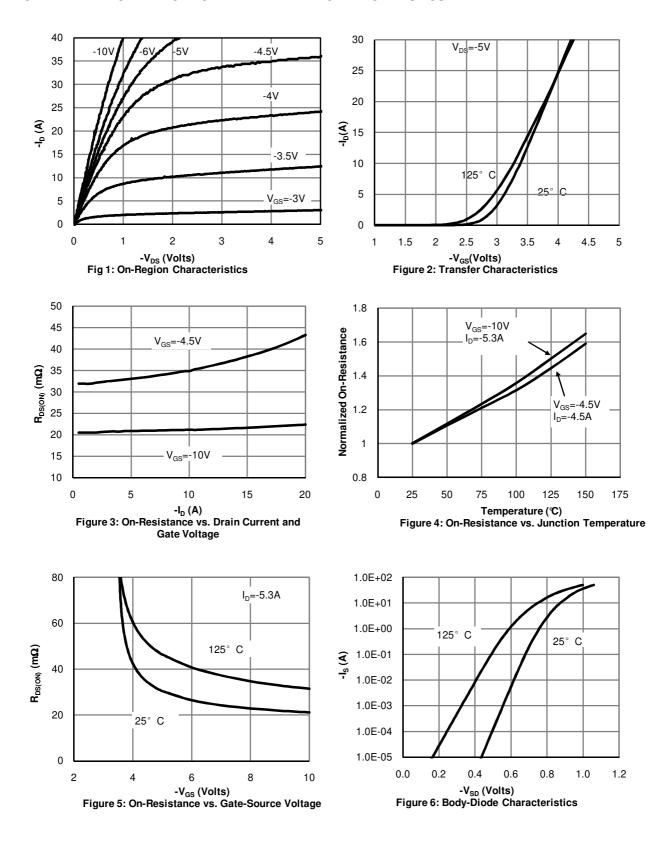
D. The static characteristics in Figures 1 to 6 are obtained using <300 µs pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in ² FR-4 board with 2oz. Copper, in a still air environment with

 $T_A=25^{\circ}$ C. The SOA curve provides a single pulse rating.

F.The current rating is based on the $t \leqslant 10\text{s}$ thermal resistance rating.

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